APPLICA	BLE STAN	DARD										
	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE APPLICABLE CONNECTOR APPLICABLE CONTACT		-35 °C TO +85°C (NOTE1)  20% TO 80% (NOTE2)  DF57H-4S-1.2C(##) DF57AH-4S-1.2C(##)		STORAGE TEMPERATURE RANGE			-10 °C TO +60°C (NOTE3)				
RATING					STORAG	GE TY RANGE OPERATING TEMPERATURE			40% TO 70% (NC			
					UL· C-UL			RE				
			DF57-***SCF(##)		RATING		TAGE		29 V AC/DC			
	VOLTAGE CURRENT		50 V AC/DC 26 TO 28 AWG : 1.5A/P 30 AWG : 1.0A/P 32 AWG : 0.8A/P 34 AWG : 0.5A/P	IN PIN	2	CUF			26 TO 28 AWG : 1.5 <i>A</i> 30 TO 34 AWG : 1.0 <i>A</i>			
	1		SPECI		NOITA	IS						
IT	EM		TEST METHOD	1 107	111011		R	FQUI	REMENTS	QT	AT	
CONSTRU	JCTION	I			I					<b> </b>	1	
GENERAL E	XAMINATION	VISUALLY	AND BY MEASURING INSTRU	MENT.	A	CCOR	DING TO I	DRAW	ING.	X	Х	
MARKING		CONFIRMED VISUALLY.									Х	
	IC CHARA				1							
CONTACT RESISTANCE MILLIVOLT LEVEL METHOD		20mV MAX, 1mA (DC or 1000Hz).				10 mΩ MAX.				X	-	
INSULATION RESISTANCE		100 V DC.				100 MΩ MIN.				X	_	
VOLTAGE PROOF		500 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.					_	
	IICAL CHA				1	,			05.00.0.141	1 37		
MECHANICA OPERATION		30 TIMES INSERTION AND EXTRACTION.				1)CONTACT RESISTANCE: 20 m Ω MAX. 2)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	_	
CONTACT INSERTION		IT TAKES OUT AND INSERTS WITH A CONFORMITY CONNECTOR.				1)INSERTION FORCE : 24.0N MAX.				Х	_	
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE				2)EXTRACTION FORCE: 1.2N MIN. 1)NO ELECTRICAL DISCONTINUITY OF 1 μ s.					_	
SHOCK		0.75 mm, AT 10 CYCLES FOR 3 DIRECTION. 490 m/s <sup>2</sup> DURATION OF PULSE 11 ms AT 3 TIMES FOR 3				2)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	+-	
	NACNITAL O	DIRECTIO										
DAMP HEAT	MENTAL C		AT 40 ± 2°C, 90 TO 95 %, 96	3 h.	11	)CON	TACT RE	SIST	ANCE: 20 mΩ MAX.	X	Τ_	
(STEADY STATE)		(AFTER LEAVING THE ROOM TEMPERATURE FOR 1-2h.)			OR 1-2h.) 2	2)INSULATION RESISTANCE: 100 M $_{\Omega}$ MIN. 3)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.						
RAPID CHANGE OF TEMPERATURE						1)CONTACT RESISTANCE: $20 \text{ m}\Omega$ MAX. 2)INSULATION RESISTANCE: $100 \text{ M}\Omega$ MIN. 3)NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	_	
RESISTANCE TO SOLDERING HEAT		1) REFLOW SOLDERING			IAX.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.					_	
SOLDERABILI			SOLDERING TEMPERATURE : 245°C DURATION OF IMMERSION :SOLDERING, FOR 5 sec.			NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				Х	-	
NOTE2:NO CO NOTE3:APPL	ONDENSING. Y TO THE CONE	OITION OF L	ISING BY CURRENT. ONG TERM STORAGE FOR UND HUMIDITY RANGE IS APPLIE		RODUCTS	BEFO	RE MOUN	TED C		ON P	CB,	
COUN	T DE	SCRIPTIO			DESIGN	GNED CHECKED				DA	ATE	
1		DIS-H-00005763 HK. HA			HK. HAYAS	YASHI			SZ. 0NO 2		00220	
REMARKS							APPRO\	/ED	KI. AKIYAMA	+	20319	
							CHECK		HK. UMEHARA	+	20319	
Unless other	erwise specif	ied, refer	er to IEC 60512.			DESIGNED			TS. KUMAZAWA TS. KUMAZAWA	20120319		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRAWING NO.				ELC-343906-21-01			
ĸ		SPECIFICATION SHEET			PART N	NO.		DI	DF57H-4P-1. 2V (21)			
	HIR	HIROSE ELECTRIC CO., LTD.			CODE N	NO.	o.   <b>CL666</b> -		-0106-2-21	<u>A</u>	1/1	